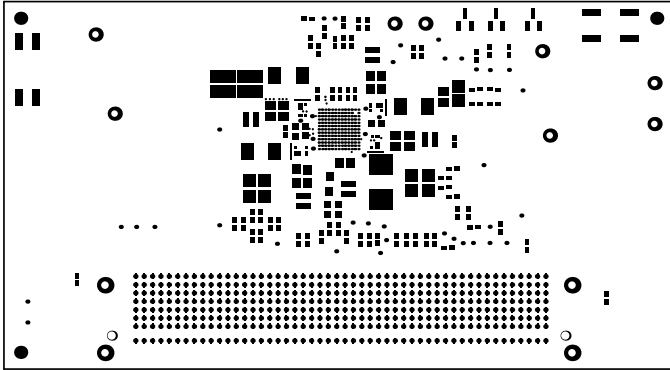
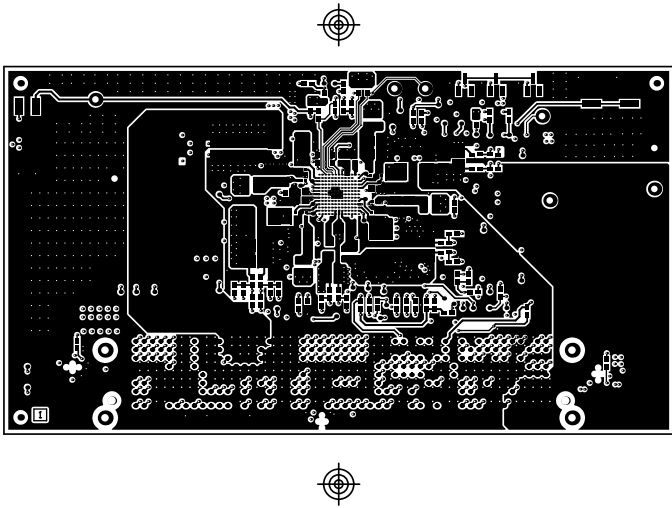


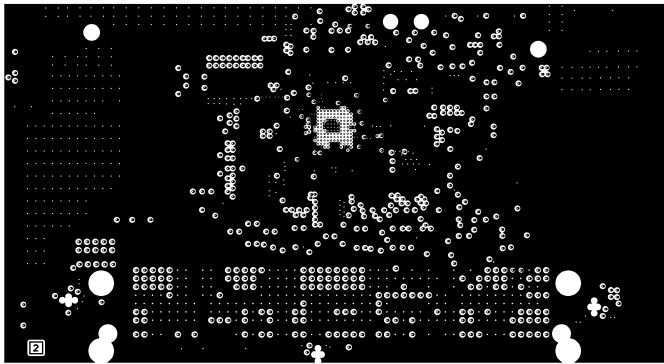
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9548	REV: REVE2	SUN REV: Not In VersionControl
LAYER NAME = TOP SILK	SHEET #: 13 OF 18		
PLOT NAME = Top Overlay	GENERATED : 5/30/2014 10:22:39 AM		TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9548	REV: REVE2	SUN REV: Not In VersionControl
LAYER NAME = TOP MASK	SHEET #: 9 OF 18		
PLOT NAME = Top Solder Mask	GENERATED : 5/30/2014 10:22:41 AM	TEXAS INSTRUMENTS	

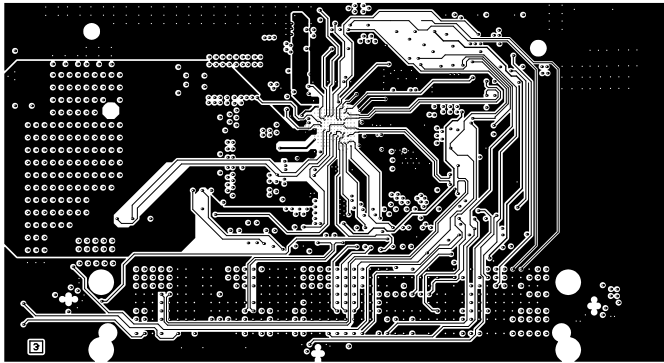


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9548	REV: REVE2	SUN REV: Not In VersionControl
LAYER NAME = TOP LAYER(DUT)	SHEET #: 1 OF 18		
PLOT NAME = Top Layer	GENERATED : 5/30/2014 10:22:42 AM		TEXAS INSTRUMENTS



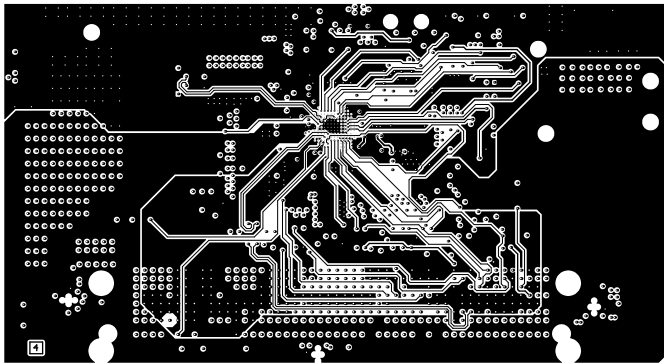
GND PLANE

2



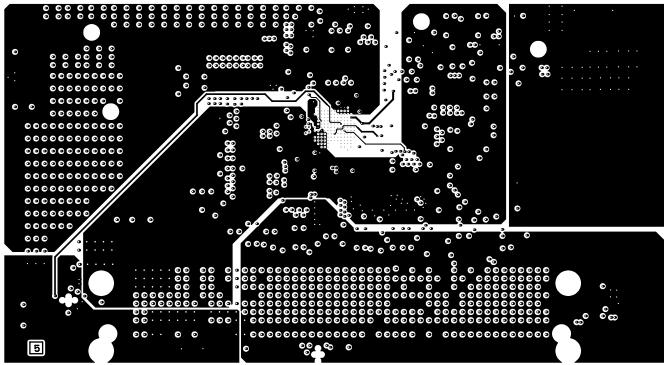
SIGNAL 1

3



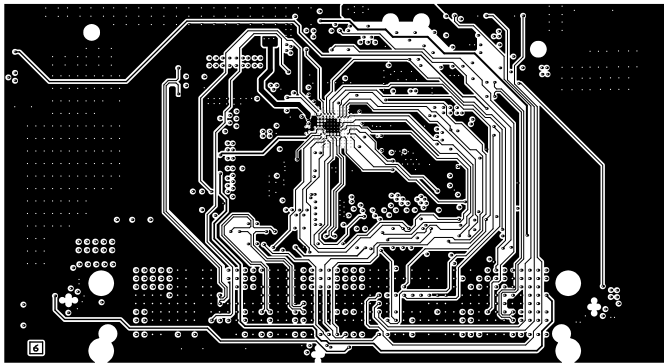
MULTI 1

4



MULTI 2

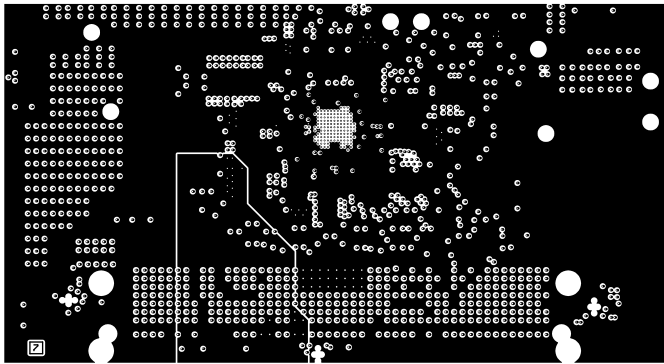
5



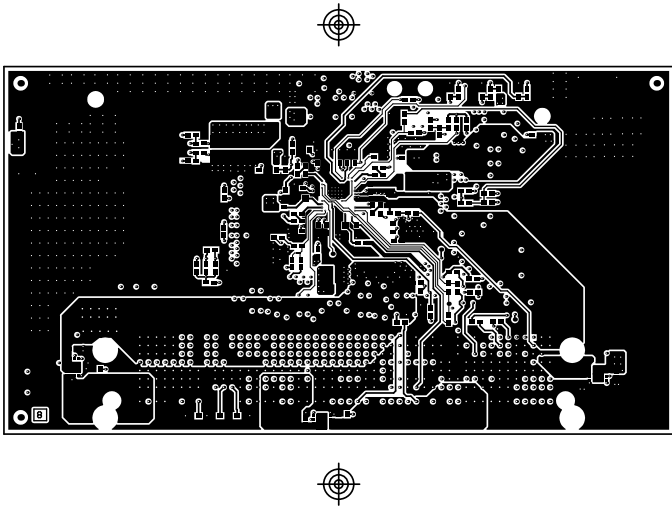
SIGNAL 2

6

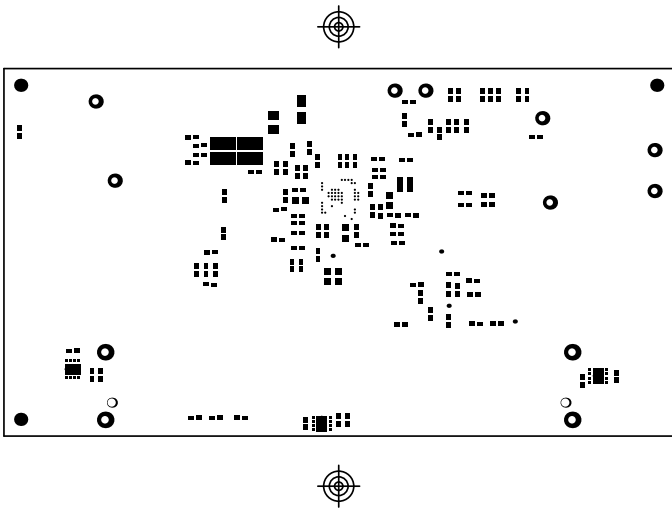




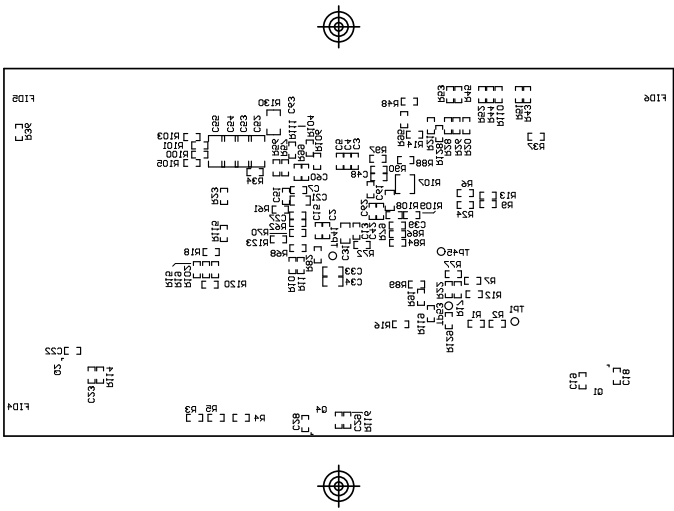
POWER SPLIT PLANE



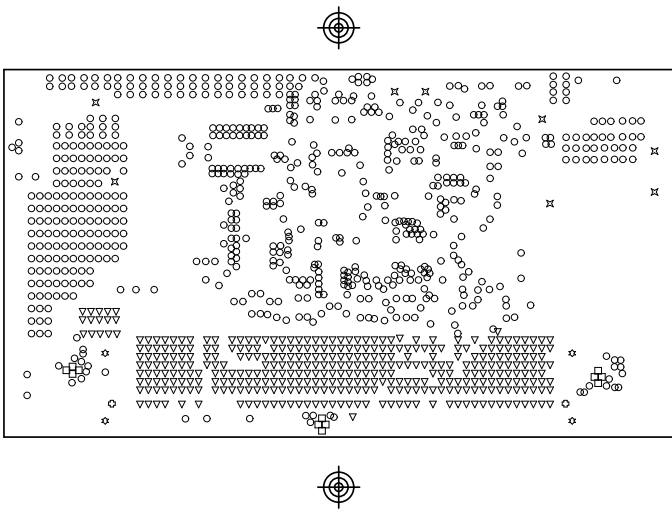
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9548	REV: REVE2	SUN REV: Not In VersionControl
LAYER NAME = BOTTOM LAYER	SHEET #: 8 OF 18		
PLOT NAME = Bottom Layer	GENERATED : 5/30/2014	10:24:15 AM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9548	REV: REVE2	SUN REV: Not In VersionControl
LAYER NAME = BOTTOM MASK	SHEET #: 10 OF 18		
PLOT NAME = Bottom Solder Mask	GENERATED : 5/30/2014 10:24:16 AM	TEXAS INSTRUMENTS	



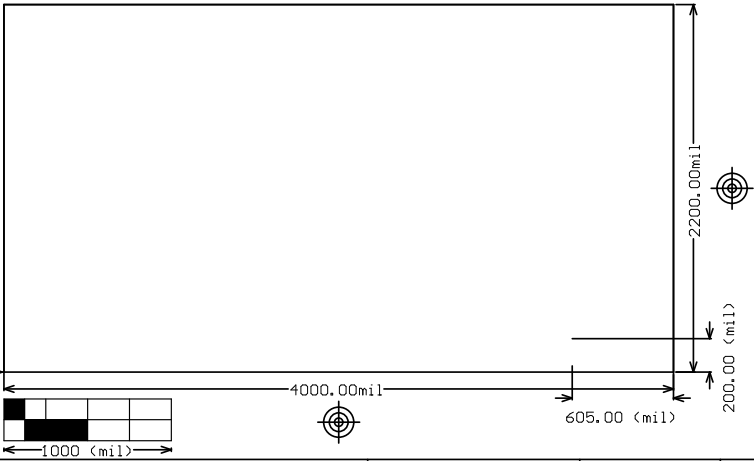
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9548	REV: REVE2	SUN REV: Not In VersionControl
LAYER NAME = BOTTOM SILK	SHEET #: 14 OF 18		
PLOT NAME = Bottom Overlay	GENERATED : 5/30/2014	10:24:17 AM	TEXAS INSTRUMENTS



Symbol	Ht Count	Tool Size	Plated	Hole Type
o	696	8mil (0.203mm)	PTH	Round
□	12	8.01mil (0.203mm)	PTH	Round
v	368	10mil (0.254mm)	PTH	Round
9	9	40mil (1.016mm)	PTH	Round
x	4	45.276mil (1.15mm)	PTH	Round
o	2	50mil (1.27mm)	NPTH	Round
1090 Total				

Drill Table

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9548	REV: REVE2	SUN REV: Not In VersionControl
LAYER NAME =	SHEET #: OF 18		
PLOT NAME = Drill Drawing	GENERATED : 5/30/2014 10:24:18 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9548	REV: REVE2	SUN REV: Not In VersionControl
LAYER NAME =	SHEET #: OF 18		
PLOT NAME = Board Dimensions	GENERATED : 5/30/2014 10:24:18 AM	TEXAS INSTRUMENTS	

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